Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

REMINDERS

Product information in this catalog is as of October 2015. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that TAIYO YUDEN CO., LTD. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact TAIYO YUDEN CO., LTD. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,(automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact TAIYO YUDEN CO., LTD. for more detail in advance.

Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN's official sales channel").

 It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.
- Please note that TAIYO YUDEN CO., LTD. shall have no responsibility for any controversies or disputes that may
- occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. TAIYO YUDEN CO., LTD. grants no license for such rights.
- Caution for export

Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

MULTILAYER CHIP INDUCTORS(CK SERIES / CK SERIES S TYPE)





■PARTS NUMBER

* Operating Temp.:-40~+85°C



 Δ =Blank space

3 0 ·	
(1)Series	name

Code	Series name					
CK△	AA DOLLAR DE LA COLLAR					
CKS	Multilayer chip inductor					

3 Nominal inductance

1) Series Harrie				
Code	Series name			
CK△	Modellesses also indeed a			
CKS	Multilayer chip inductor			

(example)	Nominal inductance[μ H]						
1R0	1.0						
100	10						
XR=Decimal point							

②Dimensions (L × W)

Code	Type (inch)	Dimensions (L×W)[mm]
1608	1608 (0603)	1.6 × 0.8
2125	2125(0805)	2.0 × 1.25

4) Inductance tolerance					
Code	Inductance tolerance				
М	±20%				

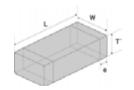
-	_					
5)	Pa	Cł	(a	8,1	n	ō.

On achaging	
Code	Packaging
-T	Taping

6Internal code

Code	Internal code
Δ	Standard

■ STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Type	_	W	т.		Standard quantity[pcs]		
Туре	_	VV		e	Paper tape	Embossed tape	
CK 1608 1.6±0.15		0.8±0.15	0.8±0.15	0.3±0.2	4000		
(0603)	(0.063 ± 0.006)	(0.031 ± 0.006)	(0.031 ± 0.006)	(0.012 ± 0.008)	4000		
OK 010E	2.0+0.3/-0.1	1.25±0.2	0.85±0.2	0.5 ± 0.3	4000	_	
CK 2125 CKS2125 (0805)	(0.079 + 0.012 / -0.004)	(0.049 ± 0.008)	(0.033 ± 0.008)	(0.020 ± 0.012)	4000		
	2.0+0.3/-0.1	1.25±0.2	1.25±0.2	0.5±0.3		2000	
	(0.079+0.012/-0.004)	(0.049 ± 0.008)	(0.049 ± 0.008)	(0.020 ± 0.012)	_	2000	

Unit:mm(inch)

■PARTS NUMBER

CK1608

Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω]($\pm 30\%$)	Rated current [mA] (max.)	Measuring frequency [MHz]	Thickness [mm]
CK 1608 4R7M-T	RoHS	4.7	±20%	25	0.45	60	4	0.80 ± 0.15
CK 1608 100M-T	RoHS	10.0	±20%	17	0.85	50	2	0.80 ±0.15

CK2125

- OIKE I EU									
Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	Self-resonant frequency	DC Resistance[Ω]		Rated current [mA] (max.)	Measuring frequency	Thickness [mm]
				[MHz] (min.)	(max.)	(typ.)		[MHz]	
CK 2125 R10M-T	RoHS	0.10	±20%	235	0.16	0.08	500	25	0.85 ± 0.2
CK 2125 R15M-T	RoHS	0.15	±20%	200	0.20	0.13	500	25	0.85 ±0.2
CK 2125 R22M-T	RoHS	0.22	±20%	170	0.23	0.16	400	25	0.85 ± 0.2
CK 2125 R33M-T	RoHS	0.33	±20%	145	0.28	0.21	400	25	0.85 ± 0.2
CK 2125 R47M-T	RoHS	0.47	±20%	125	0.32	0.25	400	25	1.25 ±0.2
CK 2125 R68M-T	RoHS	0.68	±20%	105	0.45	0.35	300	25	1.25 ±0.2
CK 2125 1R0M-T	RoHS	1.0	±20%	75	0.26	0.19	220	10	0.85 ±0.2
CK 2125 1R5M-T	RoHS	1.5	±20%	60	0.28	0.23	170	10	0.85 ± 0.2
CK 2125 2R2M-T	RoHS	2.2	±20%	50	0.35	0.26	150	10	0.85 ± 0.2
CK 2125 3R3M-T	RoHS	3.3	±20%	41	0.43	0.38	130	10	1.25 ±0.2
CK 2125 4R7M-T	RoHS	4.7	±20%	35	0.48	0.44	120	10	1.25 ±0.2
CK 2125 6R8M-T	RoHS	6.8	±20%	29	0.52	0.39	70	4	1.25 ±0.2
CK 2125 100M-T	R₀HS	10.0	±20%	24	0.65	0.55	60	2	1.25 ±0.2

CKS2125

Parts number	EHS	Nominal inductance	Inductance tolerance frequency		tance[Ω]	Rated current [mA] (max.)	Measuring frequency	Thickness [mm]	
		[[[]		[MHz] (min.)	(max.)	(typ.)	[IIIA] (IIIax.)	[MHz]	Limiti
CKS2125 1R0M-T	R₀HS	1.0	±20%	75	0.12	0.09	280	10	0.85 ± 0.2
CKS2125 2R2M-T	RoHS	2.2	±20%	50	0.19	0.15	170	10	0.85 ±0.2
CKS2125 4R7M-T	RoHS	4.7	±20%	35	0.30	0.25	130	10	1.25 ±0.2
CKS2125 100M-T	RoHS	10.0	±20%	24	0.52	0.40	110	2	1.25 ±0.2

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Multilayer chip inductors Multilayer chip inductors for high frequency, Multilayer chip bead inductors Multilayer common mode choke coils (MC series F type) Metal Multilayer Chip Power Inductors (MCOILTM MC series)

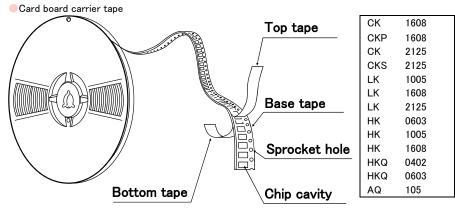
PACKAGING

1 Minimum Quantity

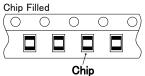
Tape & Reel Packaging			
Tura	Thickness	Standard Q	uantity [pcs]
Type	mm(inch)	Paper Tape	Embossed Tape
CK1608(0603)	0.8 (0.031)	4000	_
CK2125 (0805)	0.85(0.033)	4000	_
GK2120 (0000)	1.25(0.049)	_	2000
CKC313E(000E)	0.85(0.033)	4000	_
CKS2125 (0805)	1.25(0.049)	_	2000
CKP1608 (0603)	0.8 (0.031)	4000	_
CKP2012 (0805)	0.9 (0.035)	_	3000
CKP2016 (0806)	0.9 (0.035)	_	3000
	0.7 (0.028)	_	3000
CKP2520(1008)	0.9 (0.035)	_	3000
	1.1 (0.043)	_	2000
NM2012 (0805)	0.9 (0.035)	_	3000
	0.9 (0.035)	_	3000
NM2520(1008)	1.1 (0.043)	_	2000
LK1005(0402)	0.5 (0.020)	10000	_
LK1608 (0603)	0.8 (0.031)	4000	_
	0.85(0.033)	4000	_
LK2125 (0805)	1.25(0.049)	_	2000
HK0603(0201)	0.3 (0.012)	15000	_
HK1005 (0402)	0.5 (0.020)	10000	_
HK1608(0603)	0.8 (0.031)	4000	_
HK2125(0805)	0.85 (0.033)	_	4000
	1.0 (0.039)	_	3000
HKQ0402(01005)	0.2 (0.008)	20000	40000
HKQ0603W(0201)	0.3 (0.012)	15000	
HKQ0603C (0201)	0.3 (0.012)	15000	_
HKQ0603S (0201)	0.3 (0.012)	15000	_
HKQ0603U(0201)	0.3 (0.012)	15000	_
AQ105(0402)	0.5 (0.020)	10000	_
BK0402(01005)	0.2 (0.008)	20000	_
BK0603(0201)	0.3 (0.012)	15000	
BK1005(0402)	0.5 (0.020)	10000	 _
BKH0603(0201)	0.3 (0.012)	15000	_
BKH1005(0402)	0.5 (0.020)	10000	_
BK1608(0603)	0.8 (0.031)	4000	_
DI(1000(0003)	0.85 (0.031)	4000	_
BK2125 (0805)	1.25(0.049)	4000	2000
BK2010(0804)	0.45(0.018)	4000	2000
BK3216(1206)	0.43(0.018)	1	4000
	0.8 (0.031)	20000	4000
BKP0402 (01005) BKP0603 (0201)	0.2 (0.008)	20000 15000	
			
BKP1005 (0402) BKP1608 (0603)	0.5 (0.020) 0.8 (0.031)	10000	-
BKP1608 (0603) BKP2125 (0805)		4000	
	0.85 (0.033)	4000 15000	
MCF0605 (0202)	0.3 (0.012)	10000	10000
MCF0806 (0302)	0.4 (0.016)	_	10000
MCF1210 (0504)	0.55(0.022)	_	5000
MCF2010(0804)	0.45 (0.018)	4000	4000
MCFE1608 (0603)	0.65(0.026)	4000	-
MCKK2012 (0805)	1.00(0.039)	_	3000

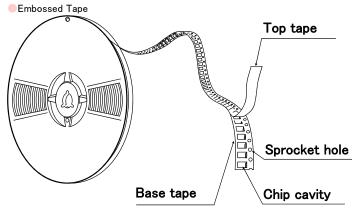
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2Taping material



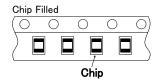
BK	0402	
BK	0603	
BK	1005	
BK	1608	
BK	2125	
BK	2010	
BKP	0402	
BKP	0603	
BKP	1005	
BKP	1608	
BKP	2125	
BKH	0603	
BKH	1005	
MCF	0605	
MC	1608	





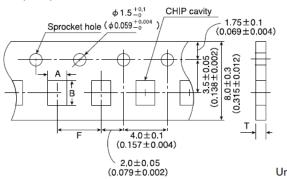
CK	2125
CKS	2125
CKP	2012
CKP	2016
CKP	2520
NM	2012
NM	2520
LK	2125
HKQ	0402
HK	2125

BK	2125	
BK	3216	
MCF	0806	
MCF	1210	
MCF	2010	
MC	2012	
	•	



3Taping Dimensions

Paper tape (8mm wide)



Unit: mm (inch)

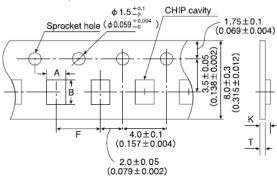
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	Thickness	Chip	cavity	Insertion Pitch	Tape Thickness
Туре	mm (inch)	A	В	F	Т
		1.0±0.2	1.8±0.2	4.0±0.1	1.1max
CK1608(0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
		1.5±0.2	2.3±0.2	4.0±0.1	1.1max
CK2125(0805)	0.85(0.033)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
		1.5±0.2	2.3±0.2	4.0±0.1	1.1max
CKS2125(0805)	0.85(0.033)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
		1.0±0.2	1.8±0.2	4.0±0.1	1.1max
CKP1608(0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
		0.65±0.1	1.15±0.1	2.0±0.05	0.8max
LK1005 (0402)	0.5 (0.020)	(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
		1.0±0.2	1.8±0.2	4.0±0.1	1.1max
LK1608 (0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
11(0405(0005)	0.05(0.000)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
LK2125 (0805)	0.85(0.033)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
	()	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HK0603(0201)	0.3 (0.012)	(0.016±0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
	()	0.65±0.1	1.15±0.1	2.0±0.05	0.8max
HK1005(0402)	0.5 (0.020)	(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
LU(1000 (0000)	0.0 (0.004)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
HK1608 (0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
HKO0400 (0100E)	0.0 (0.000)	0.25±0.04	0.45±0.04	2.0±0.05	0.36max
HKQ0402 (01005)	0.2 (0.008)	(0.010 ± 0.002)	(0.018 ± 0.002)	(0.079 ± 0.002)	(0.014max)
LIKO0603W(0301)	0.2 (0.010)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HKQ0603W(0201)	0.3 (0.012)	(0.016 ± 0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
HKO0603C (0301)	0.3 (0.012)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HKQ0603C (0201)	0.3 (0.012)	(0.016 ± 0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
HKQ0603S(0201)	0.3 (0.012)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HNQ00033(0201)	0.3 (0.012)	(0.016 ± 0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
HKQ0603U(0201)	0.3 (0.012)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HKQ00030 (0201)	0.3 (0.012)	(0.016 ± 0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
AQ105(0402)	0.5 (0.020)	0.75±0.1	1.15±0.1	2.0±0.05	0.8max
AQ100(0402)	0.0 (0.020)	(0.030 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
BK0402(01005)	0.2 (0.008)	0.25 ± 0.04	0.45 ± 0.04	2.0±0.05	0.36max
	0.2 (0.000)	(0.010 ± 0.002)	(0.018±0.002)	(0.079 ± 0.002)	(0.014max)
BK0603(0201)	0.3 (0.012)	0.40 ± 0.06	0.70±0.06	2.0±0.05	0.45max
	0.0 (0.012)	(0.016±0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
BK1005(0402)	0.5 (0.020)	0.65±0.1	1.15±0.1	2.0±0.05	0.8max
	0.0 (0.020)	(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
BK1608(0603)	0.8 (0.031)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
	, ,	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157±0.004)	(0.043max)
BK2125(0805)	0.85(0.033)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
	, ,	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
BK2010(0804)	0.45 (0.018)	1.2±0.1	2.17±0.1	4.0±0.1	0.8max
· · ·		(0.047±0.004)	(0.085 ± 0.004)	(0.157±0.004)	(0.031max)
BKP0402 (01005)	0.2 (0.008)	0.25 ± 0.04	0.45 ± 0.04	2.0±0.05	0.36max
		(0.010±0.002)	(0.018±0.002)	(0.079±0.002)	(0.014max)
BKP0603(0201)	0.3 (0.012)	0.40 ± 0.06	0.70 ± 0.06	2.0 ± 0.05	0.45max
		(0.016±0.002)	(0.028±0.002)	(0.079±0.002)	(0.018max)
BKP1005 (0402)	0.5 (0.020)	0.65 ± 0.1	1.15 ± 0.1	2.0±0.05	0.8max
	+	(0.026±0.004) 1.0±0.2	(0.045±0.004)	(0.079±0.002)	(0.031max)
BKP1608 (0603)	0.8 (0.031)	(0.039 ± 0.008)	1.8±0.2 (0.071±0.008)	4.0±0.1	1.1max (0.043max)
		(0.039±0.008) 1.5±0.2	2.3±0.2	(0.157±0.004) 4.0±0.1	(0.043max) 1.1max
BKP2125 (0805)	0.85(0.033)	(0.059±0.008)	(0.091 ± 0.008)	4.0±0.1 (0.157±0.004)	(0.043max)
		0.40±0.06	0.70±0.06	2.0±0.05	0.45max
BKH0603(0201)	0.3 (0.012)	(0.40±0.06 (0.016±0.002)	(0.028±0.002)	(0.079±0.002)	0.45max (0.018max)
		0.016±0.002)	1.15±0.1		
BKH1005(0402)	0.5 (0.020)	(0.026±0.004)	(0.045±0.004)	2.0±0.05 (0.079±0.002)	0.8max (0.031max)
		0.62±0.03	0.77±0.03	2.0±0.05	0.45max
MCF0605(0202)	0.3 (0.012)	(0.024±0.001)	(0.030 ± 0.001)	(0.079±0.002)	(0.018max)
		1.1±0.05	1.9±0.05	4.0±0.1	0.72max
MCFE1608(0603)	0.65(0.026)	(0.043 ± 0.002)	(0.075 ± 0.002)	(0.157±0.004)	(0.028max)
	1	(0.040 ± 0.002)	(0.070 ± 0.002)	(0.107 ± 0.004)	Unit: mm (inch)

Unit: mm(inch)

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Embossed Tape (8mm wide)



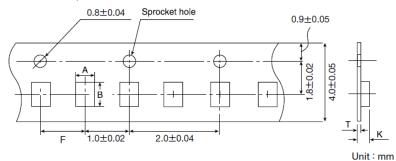
Unit: mm (inch)

T	Thickness	Chip	cavity	Insertion Pitch	Tape Thickness		
Туре	mm(inch)	Α	В	F	K	Т	
CK2125(0805)	1.25 (0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)	
CKS2125(0805)	1.25 (0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)	
CKP2012 (0805)	0.9 (0.035)	1.55±0.2 (0.061±0.008)	2.3 ± 0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.3 (0.012)	
CKP2016 (0806)	0.9 (0.035)	1.8±0.1 (0.071±0.004)	2.2 ± 0.1 (0.087±0.004)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.25 (0.01)	
	0.7 (0.028)				1.4 (0.055)		
CKP2520 (1008)	0.9 (0.035)	2.3±0.1 (0.091±0.004)	2.8±0.1 (0.110±0.004)	4.0±0.1 (0.157±0.004)	1.4 (0.055)	0.3 (0.012)	
	1.1 (0.043)				1.7 (0.067)		
NM2012 (0805)	0.9 (0.035)	1.55±0.2 (0.061±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.3 (0.012)	
NM2520 (1008)	0.9 (0.035)	2.3±0.1	2.8±0.1	4.0±0.1	1.4 (0.055)	0.3	
	1.1 (0.043)	(0.091 ± 0.004)	(0.110±0.004)	(0.157±0.004)	1.7 (0.067)	(0.012)	
LK2125 (0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)	
	0.85 (0.033)	1.5±0.2	2.3±0.2	4.0±0.1	1.5 (0.059)	0.3	
HK2125 (0805)	1.0 (0.039)	(0.059 ± 0.008)	(0.091±0.008)	(0.157±0.004)	2.0 (0.079)	(0.012)	
BK2125(0805)	1.25 (0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)	
BK3216(1206)	0.8(0.031)	1.9±0.1 (0.075±0.004)	3.5±0.1 (0.138±0.004)	4.0±0.1 (0.157±0.004)	1.4 (0.055)	0.3 (0.012)	
MCF0806 (0302)	0.4 (0.016)	0.75±0.05 (0.030±0.002)	0.95±0.05 (0.037±0.002)	2.0±0.05 (0.079±0.002)	0.55 (0.022)	0.3 (0.012)	
MCF1210 (0504)	0.55(0.022)	1.15±0.05 (0.045±0.002)	1.40±0.05 (0.055±0.002)	4.0±0.1 (0.157±0.004)	0.65 (0.026)	0.3 (0.012)	
MCF2010(0804)	0.45(0.018)	1.1±0.1 (0.043±0.004)	2.3±0.1 (0.091±0.004)	4.0±0.1 (0.157±0.004)	0.85 (0.033)	0.3 (0.012)	
MCKK2012(0805)	1.0 (0.039)	1.55±0.2 (0.061±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.25 (0.010)	

Unit: mm(inch)

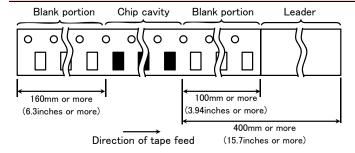
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Embossed Tape (4mm wide)

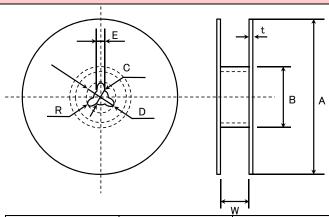


Type		Chip cavity		Insertion Pitch	Tape Th	nickness
Туре	mm(inch)	Α	В	F	K	Т
HKQ0402(01005)	0.2 (0.008)	0.23	0.43	1.0±0.02	0.5max.	0.25max.
					Unit	: mm

4LEADER AND BLANK PORTION



⑤Reel Size



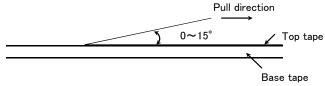
Α	В	С	D	E	R
ϕ 178 ± 2.0	ϕ 50 or more	ϕ 13.0 \pm 0.2	ϕ 21.0±0.8	2.0±0.5	1.0

	t	W
4mm width tape	1.5max.	5±1.0
8mm width tape	2.5max.	10±1.5

(Unit:mm)

$\ensuremath{\text{6}\text{Top}}$ tape strength

The top tape requires a peel-off force of $0.1 \sim 0.7 N$ in the direction of the arrow as illustrated below.



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Multilayer chip inductors

Multilayer chip inductors for high frequency, Multilayer chip bead inductors

Multilayer common mode choke coils (MC series F type)

Metal Multilayer Chip Power Inductors (MCOIL™ MC series)

■RELIABILITY DATA

1. Operating Temper	rature Range				
	BK0402				
	BK0603				
	BK1005				
	BKH0603				
	BKH1005		_55~+125°C		
	BK1608				
	BK2125				
	ADDAY	BK2010			
	ARRAY	BK3216			
	BKP0402	•			
	BKP0603				
	BKP1005				
	BKP1608				
	BKP2125				
	MCF 0605				
	MCF 0806		10 1050		
	MCF 1210		— −40~+85°C		
	MCF 2010				
	CK1608				
	CK2125				
Specified Value	CKS2125				
	CKP1608				
	CKP2012		7		
	CKP2016		T		
	CKP2520				
	NM2012				
	NM2520				
	LK1005				
	LK1608				
	LK2125		7		
	HKQ0402				
	HK0603		55~+125°C		
	HK1005				
	HK1608		10 10590		
	HK2125		-40~+85°C		
	HKQ0603W/HK	Q0603C/HKQ0603S/			
	HKQ0603U/		-55~+125°C		
	AQ105				
	MCFE1608		40 1 40 10 2 (2 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1		
	MCKK2012		-40∼+125°C (Including self-generated heat)		

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ure Range				
BK0402				
BK0603				
BK1005				
BKH0603				
BKH1005		-55~+125°C		
BK1608				
BK2125				
ADDAV	BK2010			
ARRAT	BK3216			
BKP0402	•			
BKP0603				
BKP1005		-55~+85°C		
BKP1608				
BKP2125				
MCF 0605				
MCF 0806		40 10500		
MCF 1210		-40~+85°C		
MCF 2010				
CK1608				
CK2125				
CKS2125				
CKP1608				
CKP2012				
CKP2016		40 10500		
CKP2520		-40~+85°C		
NM2012				
NM2520				
LK1005				
LK1608				
LK2125				
HKQ0402				
HK0603		55~+125°C		
HK1005				
HK1608		40 L05 ⁰ 0		
HK2125				
HKQ0603W/H	KQ0603C/HKQ0603S/			
HKQ0603U/		-55~+125°C		
AQ105				
MCFE1608		10 1000		
MCKK2012				
	BK0402 BK0603 BK1005 BK1005 BK1005 BK1008 BK11005 BK1608 BK2125 ARRAY BKP0402 BKP0603 BKP1005 BKP1608 BKP125 MCF 0605 MCF 0806 MCF 1210 MCF 2010 CK1608 CK2125 CK2125 CK2125 CK2125 CK2125 CKP1608 CKP2012 CKP2016 CKP2012 CKP2016 CKP2012 HX0603 LK11005 LK1608 LK2125 HKQ0402 HK0603 HK1005 HK1608 HK1005 HK1608 HK1005 HK1608 HK2125 HKQ0603W/HH HKQ0603W/H	BK0402 BK0603 BK1005 BK1005 BK1005 BK1608 BK11005 BK1608 BK2125 ARRAY BK3216 BK90603 BKP1005 BK91608 BKP2125 MCF 0605 MCF 0806 MCF 1210 MCF 2010 CK1608 CK2125 CKS2125 CKP2012 CKP2012 CKP2016 CKP2520 NM2012 NM2520 LK1005 LK1608 LK2125 HKQ0402 HK0603 HK1005 HK1608 LK2125 HKQ0402 HK0603 HK1005 HK1608 HK2125 HKQ0603W/HKQ0603C/HKQ0603S/ HKQ0603U/ AQ105 MCFE1608		

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BK0402
BK0603
BK1005 BKH0603 BKH1005 BKH1005 BKH1005 BK1608 BK2125 BK2125 BK2010 BK200 BK90402 BK90603 BKP0603 BKP1005 BKP0603 BKP1005 BKP0603 BKP1005 BKP1005 BKP1005 BKP1608 BKP1005 BKP1608 BKP1005 BKP1608 BKP1005 BKP1608 BKP1095 BKP1608 BKP1095 BKP1
BKH0603
BKH1005 BK1608 BK2125 BK2125 BK2010 BK3216 BK216 BK9402 BKP0402 BKP0603 BKP1005 BKP1005 BKP1005 BKP1608 BKP125 BKP1608 BKP2125 BKP1608 BKP2125 BKP2
BK1608
BK2125 ARRAY BK2010 BK3216 100~200mA DC BKP0402 0.55~1.1A DC BKP0603 0.8~1.8A DC BKP1005 BKP1005 BKP1608 1.0~3.0A DC BKP2125 1.5~4.0A DC MCF 0605 MCF 0806 0.1~0.13A DC MCF 2010 MCF 2010 CK1608 CK2125 60~500mA DC CK52125 110~280mA DC CK52125 110~280mA DC CK52125 110~280mA DC CK52125
BK2010 100mA DC BK90402 0.55~1.1A DC BKP0603 0.8~1.8A DC BKP1005 0.8~2.4A DC BKP1608 1.0~3.0A DC BKP2125 1.5~4.0A DC MCF 0605 0.05A DC MCF 0806 0.1~0.13A DC MCF 2010 0.1 ~0.15A DC CK12125 0.0~60mA DC CK2125 0.0~500mA DC CK2125 60~500mA DC CK2125 110~280mA DC
BK3216 100~200mA DC
BK3216 100~200mA DC
BKP0603
BKP1005 0.8~2.4A DC BKP1608 1.0~3.0A DC BKP2125 1.5~4.0A DC MCF 0605 0.05A DC MCF 0806 0.1~0.13A DC MCF 1210 0.1~0.15A DC MCF 2010 0.1A DC CK1608 50~60mA DC CK2125 60~500mA DC CK2125 60~500mA DC CKS125 110~280mA DC
BKP1608 1.0~3.0A DC BKP2125 1.5~4.0A DC MCF 0605 0.05A DC MCF 0806 0.1~0.13A DC MCF 1210 0.1~0.15A DC MCF 2010 0.1A DC CK1608 50~60mA DC CK2125 60~500mA DC CK2125 110~280mA DC
BKP2125 1.5~4.0A DC MCF 0605 0.05A DC MCF 0806 0.1~0.13A DC MCF 1210 0.1~0.15A DC MCF 2010 0.1A DC CK1608 50~60mA DC CK2125 60~500mA DC CKS2125 110~280mA DC
MCF 0605 0.05A DC MCF 0806 0.1~0.13A DC MCF 1210 0.1~0.15A DC MCF 2010 0.1A DC CK1608 50~60mA DC CK2125 60~500mA DC CKS2125 110~280mA DC
MCF 0806 0.1~0.13A DC MCF 1210 0.1~0.15A DC MCF 2010 0.1A DC CK1608 50~60mA DC CK2125 60~500mA DC CKS2125 110~280mA DC
MCF 1210 0.1~0.15A DC MCF 2010 0.1A DC CK1608 50~60mA DC CK2125 60~500mA DC CKS2125 110~280mA DC
MCF 2010 0.1A DC CK1608 50~60mA DC CK2125 60~500mA DC CKS2125 110~280mA DC
CK1608 50~60mA DC CK2125 60~500mA DC CKS2125 110~280mA DC
CK2125 60~500mA DC CKS2125 110~280mA DC
CKS2125 110~280mA DC
CKS2125 110~280mA DC
Specified Value CKP1608 0.35~0.9A DC
CKP2012 0.7~1.7A DC
CKP2016 0.9∼1.6A DC
CKP2520 1.1∼1.8A DC
NM2012 1.0∼1.2A DC
NM2520 0.9∼1.2A DC
LK1005 20~25mA DC
LK1608 1 ~150mA DC
LK2125 5~300mA DC
HK0603 60~470mA DC
HK1005 110~300mA DC (-55~+125°C) 200~900mA DC (-55~+85°C)
HK1608 150~300mA DC
HK2125 300mA DC
HKQ0402 100~500mA DC
HKQ0603W 100~850mA DC
HKQ0603C 160~850mA DC
HKQ0603S 130~600mA DC
HKQ0603U 190~900mA DC
AQ105 280~710mA DC
MCFE1608
MCKK2012 Idc1 :2000mA DC, Idc2 :1400mA DC

Definition of rated current:

- ·In the CK, CKS and BK Series, the rated current is the value of current at which the temperature of the element is increased within 20°C.
- •In the BK Series P type, CK Series P type, NM Series, the rated current is the value of current at which the temperature of the element is increased within 40°C.
- •In the LK, HK, HKQ0603, and AQ Series, the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 20°C.
- •In the HKQ0402(~9N1), the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 20°C.
- •In the HKQ0402(10N~), the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 25°C.
- In the MC Series, Idc1 is the DC value at which the initial L value is decreased within 30% and Idc2 is the DC value at which the temperature of element is increased within 40°C by the application of DC bias. (at 20°C)

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4. Impedance			
	BK0402		$10\sim330\Omega \pm 5\Omega(10\Omega), \pm 25\%(Other)$
	BK0603		10~1200Ω ±25%
	BK1005		10~1800Ω ±25%
	BKH0603		25~1500Ω ±25%
	BKH1005		600~1800Ω ±25%
	BK1608		22~2500Ω ±25%
	BK2125		15~2500Ω ±25%
	ARRAY BK2	010	5~1000Ω ±25%
	BK3	216	60~1000Ω ±25%
	BKP0402		$10\sim33\Omega \pm 5\Omega \times 10\Omega$, $\pm 25\% \times (Other)$
	BKP0603		$10\sim120Ω \pm 5Ω(10Ω)$, $\pm25\%(Other)$
	BKP1005		$10\sim330$ Ω ±5 Ω(EM100), ±25%(Other)
	BKP1608		33~470Ω ±25%
	BKP2125		33~330Ω ±25%
	MCF 0605		$12 \sim 90 \Omega \pm 5 \Omega (12 \Omega)$, $\pm 20\% (35 \Omega)$, $\pm 25\% (Other)$
	MCF 0806		$12 \sim 90 \Omega \pm 5 \Omega(12 \Omega)$, $\pm 20\%$ (Other)
	MCF 1210		$40 \sim 90 \Omega \pm 20\% (2H900), \pm 25\% (Other)$
	MCF 2010		90Ω ±25%
	CK1608		-
Specified Value	CK2125 CKS2125		-
	CKP1608		-
	CKP1008		-
	CKP2012 CKP2016		-
	CKP2520		-
	NM2012		-
	NM2520		-
	LK1005		-
	LK1608		-
	LK2125		-
	HKQ0402		
	HK0603		
	HK1005		
	HK1608		
	HK2125		
	HKQ0603W/HKQ0603C	/HKQ0603S/	
	HKQ0603U		
	AQ105		
	MCFE1608		
	MCKK2012		
	BK0402Series, BKP040		
	Measuring frequency	: 100±1MHz	
	Measuring equipment	: E4991A(or its eq	
	Measuring jig	: 16197A(or its eq	uivalent)
	BK0603Series, BKP060		
	Measuring frequency	: 100±1MHz : 4291A(or its equi	include)
	Measuring equipment Measuring jig	: 16193A(or its equi	
		5Series ,BKH1005Series	uivaiciit/
Test Methods and	Measuring frequency	: 100±1MHz	
Remarks	Measuring equipment	: 4291A (or its equi	ivalent)
riomanio	Measuring jig		uivalent), 16193A(or its equivalent)
	BK1608 • 2125 Series, Bh		
	Measuring frequency	: 100±1MHz	
	Measuring equipment	: 4291A (or its equi	ivalent), 4195A(or its equivalent)
	Measuring jig	: 16092A(or its eq	uivalent)or 16192A(or its equivalent)/HW
	BK2010 • 3216 Series, M		
	Measuring frequency	: 100±1MHz	
	Measuring equipment		ivalent), 4195A(or its equivalent)
	Measuring jig	: 16192A(or its eq	uivalent)

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5. Inductance	DIVO400			
	BK0402			
	BK0603		<u> </u>	
	BK1005		<u> </u>	
	BKH0603			
	BKH1005			
	BK1608			
	BK2125			
	ARRAY BK201)		
	BK321	3	_	
	BKP0402			
	BKP0603			
	BKP1005			
	BKP1608			
	BKP2125			
	MCF 0605			
	MCF 0806			
	MCF 1210]	
	MCF 2010]	
	CK1608		4.7~10.0 µH: ±20%	
	CK2125		0.1~10.0 µH: ±20%	
	CKS2125		1.0~10.0 µH: ±20%	
	CKP1608		0.33~2.2 µH: ±20%	
Specified Value	CKP2012		0.47~4.7 µH: ±20%	
	CKP2016		0.47~4.7 µH: ±20%	
	CKP2520		0.47~4.7 µH: ±20%	
	NM2012		0.82~1.0 μH: ±20%	
	NM2520		$1.0 \sim 2.2 \mu\text{H}$: $\pm 20\%$	
	LK1005		0.12~2.2 µH: ±10 or 20%	
	LK1608		0.047~33.0 μH: ±20% 0.10~12.0 μH: ±10%	
	LK2125		0.047~33.0 µH: ±20% 0.10~12.0 µH: ±10%	
	HK0603		1.0~6.2nH: ±0.3nH 6.8~100nH: ±5%	
	HK1005		1.0~6.2nH: ±0.3nH	
	HK1608		1.0~5.6nH: ±0.3nH	
	HK2125		1.5~5.6nH: ±0.3nH 6.8~470nH: ±5%	
	HKQ0402		0.5~3.9nH: ±0.1 or 0.2 or 0.3nH 4.3~5.6nH: ±0.3nH or 3% or 5% 6.2~47nH: ±3 or 5%	
			0.6~3.9nH: ±0.1 or 0.2 or 0.3nH 4.3~6.2nH: ±0.2 or 0.3nH or 3 or 5%	
	HKQ0603W		6.8~27nH: ±3 or 5% 33~100nH: ±5%	
	HKQ0603C		0.6~3.9nH: ±0.1 or 0.2 or 0.3nH 4.3~6.2nH: ±0.2 or 0.3nH 6.8~22nH: ±3 or 5%	
	HKQ0603S		0.6~6.2nH: ±0.2 or 0.3nH 6.8~22nH: ±3 or 5%	
	HKQ0603U		0.6~4.2nH: ±0.1 or 0.2 or 0.3nH 4.3~6.5nH: ±0.2 or 0.3nH 6.8~22nH: ±3 or 5%	
	AQ105		1.0~6.2nH: ±0.3nH 6.8~15nH: ±5%	
			0.24~1.0 µH: ±20%	
	MCFE1608		1.0 μH: ±20%	
-	MCKK2012 CK, LK, CKP, NM, MC Series		1.0 μπ. ±20%	
		:ries : 2~4MHz(CK1)	cuo)	
	Measuring frequency Measuring frequency			
	Measuring frequency	: 2~25MHz(CK) : 2~10MHz(CK)		
	Measuring frequency	: 10~25MHz(Lk		
	Measuring frequency	: 1~50MHz(LK1		
	Measuring frequency	: 0.4~50MHz(LI		
	Measuring frequency		8 · CKP2012 · CKP2016 · CKP2520 · NM2012 · NM2520 · MCFE1608 · MCKK2012)	
	Measuring equipment /jig		iB+16092A(or its equivalent) •4195A+41951+16092A(or its equivalent)	
	Wodau ing equipment / Jig		2A(or its equivalent) •4291A+16193A(or its equivalent)/LK1005	
			41A + 42842C + 42851 - 61100 (or its equivalent) / CKP1608 · CKP2012 · CKP2016 · CKP2520 · NM2012 ·	
			E1608•MCKK2012	
Test Methods and	Measuring current	:•1mA rms(0.04		
Remarks		•0.1mA rms(5.		
	HK、HKQ、AQ Series	• · · · · · · · · · · · · · · · · · · ·		
	Measuring frequency	· 100MHz(HK06)	03•HK1005•AQ105)	
	Measuring frequency	: 50/100MHz(H		
	Measuring frequency		1603C·HKQ0603S·HKQ0603U)	
	Measuring frequency	: 300/500MHz(H		
	Measuring frequency	: 100/500MHz(H		
	Measuring equipment /jig		A(or its equivalent)/HK0603•AQ105	
	3 ,		3A(or its equivalent)/HK1005	
			97A(or its equivalent)/HKQ0603S+HKQ0603U+HKQ0603W+HKQ0603C	
			2A + in-house made jig(or its equivalent)/HK1608•HK2125	
			96D (or its equivalent) /HKQ0402	
	E-700 IN 1 101000 (of 100 oquivalents//TillQu-702			

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6. Q			
	BK0402		
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY BK2010		
	BK3216		_
	BKP0402		-
	BKP0603		-
	BKP1005		-
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		-
	MCF 2010		
	CK1608 CK2125		1
	CKS2125		-
Specified Value	CK92123 CKP1608		1
	CKP2012		_
	CKP2016		1
	CKP2520		1
	NM2012		
	NM2520		
	LK1005		10~20 min.
	LK1608		10~35 min.
	LK2125		15∼50 min.
	HK0603		4~5 min.
	HK1005		8 min.
	HK1608		8~12 min.
	HK2125		10~18 min.
	HKQ0402		3∼8 min.
	HKQ0603W		6~15 min.
	HKQ0603C		14∼15 min.
	HKQ0603S		10~13 min.
	HKQ0603U		14 min.
	AQ105		8 min.
	MCFE1608		_
	MCKK2012 LK Series		
	Measuring frequency	: 10~25MHz(LK10	105)
	Measuring frequency	: 1~50MHz(LK160	
	Measuring frequency	: 0.4~50MHz(LK21	
	Measuring equipment /jig		+16092A(or its equivalent)
			-16092A(or its equivalent)
			(or its equivalent)
			(or its equivalent)/LK1005
	Measuring current	1mA rms(0.047	
Test Methods and		•0.1mA rms(5.6~	γ33 μH)
Remarks	HK, HKQ, AQ Series	1001111 /111/0000	LIKTORE ACTOR)
	Measuring frequency	: 100MHz(HK0603• : 50/100MHz(HK16	
	Measuring frequency Measuring frequency		30°HKQ0603S•HKQ0603U)
	Measuring frequency	: 300/500MHz(HKC	
	Measuring frequency	: 100/500MHz(HKC	
	Measuring equipment /jig		or its equivalent)/HK0603·AQ105
			(or its equivalent)/HK1005
		•E4991A+16197A	A(or its equivalent)/HKQ0603S+HKQ0603U+HKQ0603W+HKQ0603C
			+ in-house made jig(or its equivalent)/HK1608, HK2125
		•E4991A+16196	D(or its equivalent)HKQ0402
	·	·	

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	BK0402		0.07~1.2 Ω max.	
	BK0603		0.065∼1.50 Ω max.	
	BK1005		0.03~0.90 Ω max.	
	BKH0603		0.26~3.20 Ω max.	
	BKH1005		0.85~2.00 Ω max.	
	BK1608		0.05~1.10 Ω max.	
	BK2125		0.05~0.75Ω max.	
	ARRAY	BK2010	0.10~0.90Ω max.	
	ARRAT	BK3216	0.15~0.80 Ω max.	
	BKP0402		0.05~0.15Ω max.	
	BKP0603		0.030∼0.180Ω max.	
	BKP1005		0.0273~0.220 Ω max.	
	BKP1608		0.025~0.18Ω max.	
	BKP2125		0.020∼0.075 Ω max.	
	MCF 0605		2.5∼6.5 Ω max	
	MCF 0806		2.5~5.0 Ω max.	
	MCF 1210		2.5~4.5 Ω max.	
	MCF 2010		4.5Ω max.	
	CK1608		$0.45 \sim 0.85 \Omega(\pm 30\%)$	
	CK2125		0.16∼0.65 Ω max.	
pecified Value	CKS2125		0.12~0.52 Ω max.	
Jecilied Value	CKP1608		0.15~0.35 Ω max.	
	CKP2012		0.08 ~ 0.28 Ω max.	
	CKP2016		0.075∼0.20Ω max	
	CKP2520		0.05~0.16Ω max.	
	NM2012		0.10~0.15Ω max.	
	NM2520		0.11~0.22 Ω max.	
	LK1005		0.41∼1.16Ω max.	
	LK1608		0.2~2.2Ω max.	
	LK2125		0.1~1.1 Ω max.	
	HK0603		0.11∼3.74Ω max.	
	HK1005		0.08∼4.8Ω max.	
	HK1608		0.05~2.6 Ω max.	
	HK2125		0.10~1.5Ω max.	
	HKQ0402		0.08~5.0Ω max.	
	HKQ0603W		0.07~4.1 Ω max.	
	HKQ0603C		0.07~1.6Ω max.	
	HKQ0603S		0.06∼1.29 Ω max.	
	HKQ0603U		0.06~1.29 Ω max.	
	AQ105		0.07~0.45Ω max.	
	MCFE1608		0.100~0.340Ω max.	
ļ	MCKK2012		0.123Ω max.	

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8. Self Resonance Fre							
	BK0402						
	BK0603						
	BK1005						
	BKH0603						
	BKH1005						
	BK1608						
	BK2125						
	ARRAY	BK2010					
		BK3216					
	BKP0402						
	BKP0603						
	BKP1005						
	BKP1608						
	BKP2125						
	MCF 0605						
	MCF 0806						
	MCF 1210						
	MCF 2010						
	CK1608		17∼25MHz min.				
	CK2125		24~235MHz min.				
Specified Value	CKS2125		24~75MHz min.				
Specified value	CKP1608						
	CKP2012						
	CKP2016		_				
	CKP2520						
	NM2012						
	NM2520						
	LK1005		40~180MHz min.				
	LK1608		9~260MHz min.				
	LK2125		13∼320MHz min.				
	HK0603		900∼10000MHz min.				
	HK1005		400∼10000MHz min.				
	HK1608		300∼10000MHz min.				
	HK2125		200∼4000MHz min.				
	HKQ0402		1200~10000MHz min.				
	HKQ0603W		800∼10000MHz min.				
	HKQ0603C		2500~10000MHz min.				
	HKQ0603S		1900~10000MHz min.				
	HKQ0603U		1900~10000MHz min.				
	AQ105		2300~10000MHz min.				
	MCFE1608						
	MCKK2012		_				
	LK, CK Series :						
T . M	Measuring equip	oment : 4195A (or its equi	valent)				
Test Methods and	Measuring jig	: 41951+16092A (or its equivalent)				
Remarks	HK, HKQ, AQ Se	eries :					
	Measuring equip	oment : 8719C(or its equi	ivalent) •8753D (or its equivalent) /HK2125				

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9. Temperature Chara							
	BK0402						
	BK0603						
	BK1005						
	BKH0603						
	BKH1005						
	BK1608						
	BK2125						
		BK2010					
		BK3216					
	BKP0402						
	BKP0603						
	BKP1005						
	BKP1608						
	BKP2125						
	MCF 0605			7			
	MCF 0806			_			
	MCF 1210						
	MCF 2010						
	CK1608						
	CK2125						
	CKS2125						
Specified Value	CKP1608			7			
	CKP2012						
	CKP2016			7			
	CKP2520			1			
	NM2012			7			
	NM2520						
	LK1005			7			
	LK1608			٦			
	LK2125			٦			
	HK0603			†			
	HK1005			1			
	HK1608			┪			
	HK2125			┪			
	HKQ0402			┪			
	HKQ0603W			┪			
	HKQ0603V			┥	Inductance change: Within ±10%		
				┪			
	HKQ0603S			\dashv			
	HKQ0603U			4			
	AQ105			4			
	MCFE1608			4			
	MCKK2012						
	HK、HKQ、AQ Seri						
	Temperature rang		: −30~+85°C				
Test Methods and	Reference temper	ature	: +20°C				
Remarks	MC Series:		40 1.0=05				
	Temperature rang		: −40~+85°C				
	Reference temper	ature	: +20°C				

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10. Resistance to Flex	ure of Substrate		
	BK0402		
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
		BK2010	
	ARRAY	BK3216	
	BKP0402	BROZIO	
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608 CK2125		
Specified Value	CKS2125		No mechanical damage.
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HK0603		
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MCFE1608		
	MCKK2012		
	Warp		ize, BKP, BKH1005, CK, CKS, CKP, NM, LK, HK, HKQ0603S, HKQ0603U,
		AQ Series, MCF1210, MC Ser	
	To add to a 1		0603、HKQ0402、HKQ0603W、HKQ0603C Series、MCF Series without 1210 size,)
	Testing board	: glass epoxy-resin substrate	
	Thickness	: 0.8mm	
		<u>20</u>	
Test Methods and		[D 220]	
Remarks		Board R-230	w
		Board	Warp
			\
			14
		45 45	
		← → ←	→
		1 1	(Unit:mm)
	Ī		

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11 0-14							
11. Solderability	BK0402						
	BK0603						
	BK1005						
	BKH0603						
	BKH1005						
	BK1608						
	BK2125						
		BK2010					
	ARRAY	BK3216			<u></u>		
	BKP0402				At least 75% of terminal electrode is covered by new solder.		
	BKP0603						
	BKP1005						
	BKP1608						
	BKP2125						
	MCF 0605						
	MCF 0806						
	MCF 1210						
	MCF 2010						
	CK1608						
Specified Value	CK2125						
	CKS2125						
	CKP1608						
	CKP2012						
	CKP2016						
	CKP2520						
	NM2012						
	NM2520						
	LK1005						
	LK1608						
	LK2125				At least 75% of terminal electrode is covered by new solder.		
	HK1005	HK0603					
	HK1608						
	HK2125						
	HKQ0402						
	HKQ0603W						
	HKQ0603C						
	HKQ0603S						
	HKQ0603U						
	AQ105						
	MCFE1608						
	MCKK2012						
Test Methods and	Solder temperati	ure	:230±5°	C (JIS Z 32	32 H60A or H63A)		
Remarks	Solder temperatu	ure	:245±3°	C (Sn/3.0Ag	s/0.5Cu)		
I Ciliai NS	Duration :4±1 sec.			э.			

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10 D 11 1 2 11						
12. Resistance to Sold						
1	BK0402					
ĺ	BK0603					
1	BK1005			-		
Í	BKH0603			-		
	BKH1005			1		
	BK1608			1		
!	BK2125			Appearance: No significant abnormality		
1	ARRAY	BK2010		Impedance change: Within ±30%		
!		BK3216		1		
!	BKP0402			-		
!	BKP0603			1		
!	BKP1005			1		
	BKP1608			1		
!	BKP2125					
	MCF 0605			1		
	MCF 0806			Appearance: No significant abnormality		
!	MCF 1210			Impedance change: Within ±20%		
	MCF 2010					
!	CK1608			No mechanical damage.		
	CK2125			No mechanical damage. Remaining terminal electrode: 70% min		
!	CKS2125			Transming communications and a second section of the section of the second section of the section of the second section of the section of t		
!	CKP1608			Inductance change		
	CKP2012			R10~4R7: Within ±10%		
Specified Value	CKP2016			6R8~100: Within ±15%		
!	CKP2520			CKS2125: Within ±20% CKP1608, CKP2012, CKP2016, CKP2520, NM2012, NM2520: Within ±30%		
!	NM2012					
	NM2520					
1	I	_		No mechanical damage.		
	LK1005			Remaining terminal electrode: 70% min.		
!	11/1000			Inductance change: Within ±15%		
!	LK1608			No mechanical damage.		
!				Remaining terminal electrode: 70% min.		
!	LK2125			Inductance change		
!				47N~4R7: Within ±10% 5R6~330: Within ±15%		
	HKUEU3	_	_	5R6~330: Within ±15%		
!	HK0603					
!	HK1005	_	_			
1	HK1608 HK2125					
!		_	_	No mechanical damage.		
!	HKQ0402 HKQ0603W	_	_	Remaining terminal electrode: 70% min.		
1	HKQ0603W HKQ0603C	_	_	Inductance change: Within ±5%		
!	HKQ0603C HKQ0603S			1		
!	HKQ0603S HKQ0603U			1		
!				1		
1	AQ105			No machanical damage		
!	MCFE1608			No mechanical damage. Remaining terminal electrode: 70% min.		
1	MCKK2012			Remaining terminal electrode: /0% min. Inductance change: Within ±10%		
	Solder temperatu			1 10/0		
!	Duration	. 5	:10±0.5 sec.			
Test Methods and	Preheating tempe	rature	:150 to 180°C			
Remarks	Preheating time		: 3 min.			
	_			methanol solution with colophony for 3 to 5 sec.		
1				covery under the standard condition after the test. (See Note 1)		
(Note 1) When there as		rning measureme		ement shall be made after 48±2 hrs of recovery under the standard condition.		
u			,	· · · · · · · · · · · · · · · · · · ·		

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13. Thermal Shock						
	BK0402					
	BK0603					
	BK1005					
	BKH0603					
	BKH1005					
	BK1608		Appearance: No significant abnormality			
	BK2125					
		BK2010	Impedance change			
	ARRAY	BK3216	1			
	BKP0402					
	BKP0603		1			
	BKP1005					
	BKP1608					
	BKP2125					
	MCF 0605					
	MCF 0806		Appearance: No sig	gnificant abnormality		
	MCF 1210		Impedance change	: Within ±20%		
	MCF 2010					
	CK1608		No mechanical damage.			
	CK2125		Inductance change: Within ±20% Q change: Within ±30%			
	CKS2125		Inductance change: Within ±20% (CKS2125)			
Specified Value	CKP1608					
	CKP2012		1			
	CKP2016		No mechanical dam	nage.		
	CKP2520		Inductance change			
	NM2012					
	NM2520					
	LK1005		M			
	LK1608		No mechanical dam	· ·		
	LK2125		Inductance change	: Within ±10% Q change: Within ±30%		
	HK0603					
	HK1005					
	HK1608					
	HK2125		No mechanical damage. Inductance change: Within ±10% Q change: Within ±20%			
	HKQ0402					
	HKQ0603W					
	HKQ0603C					
	HKQ0603S					
	HKQ0603U					
	AQ105		1			
	MCFE1608		Appearance: No significant abnormality			
	MCKK2012		Inductance change: Within ±10%			
	Conditions for 1	cycle	•			
	Step	temperature (°C)		time (min.)		
	1	Minimum operating temperatur	re +0/-3	30±3		
Test Methods and	2	Room temperature		2~3		
Remarks	3	Maximum operating temperatur	re +3/-0	30±3		
	4	Room temperature		2~3		
	Number of cycle	s:5				
	Recovery: 2 to 3	hrs of recovery under the standar	d condition after the	test.(See Note 1)		

(Note 1) When there are questions concerning measurement result; measurement shall be made after 48±2 hrs of recovery under the standard condition.

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14. Damp Heat (Stea	dy state)						
	BK0402						
	BK0603						
	BK1005						
	BKH0603						
	BKH1005						
	BK1608						
	BK2125		Appearance: No significant abnormality				
		BK2010	Impedance change: Within ±30%				
	ARRAY BK3216						
	BKP0402						
	BKP0603						
	BKP1005						
	BKP1608						
	BKP2125						
	MCF 0605						
	MCF 0806		Appearance: No significant abnormality				
	MCF 1210		Impedance change: Within ±20%				
	MCF 1210		ampounted straings. Highlin ±2070				
			No mark of desired desired				
	CK1608		No mechanical damage.				
	CK2125		Inductance change: Within ±20% Q change: Within ±30% Inductance change: Within ±20%				
C: G! \/-!	CKS2125		Inductance change: Within ±20%				
Specified Value	CKP1608						
	CKP2012						
	CKP2016		No mechanical damage. Inductance change:Within ±30%				
	CKP2520						
	NM2012						
	NM2520						
	LK1005		No mechanical damage.				
	LK1608		Inductance change: Within ±10% Q change: Within ±30%				
	LK2125		No mechanical damage.				
			Inductance change: Within ±20% Q change: Within ±30%				
	HK0603						
	HK1005						
	HK1608						
	HK2125						
	HKQ0402		No mechanical damage.				
	HKQ0603W		Inductance change: Within ±10% Q change: Within ±20%				
	HKQ0603C						
	HKQ0603S						
	HKQ0603U						
	AQ105						
	MC1608		Appearance: No significant abnormality				
	MC2012		Inductance change: Within ±10%				
<u> </u>	BK, BKP, BKH	Series, MCF Series:					
	Temperature	:40±2°C					
	Humidity	:90 to 95%RH					
	Duration	:500+24/-0 hrs					
	Recovery	:2 to 3 hrs of recovery under the	ne standard condition after the removal from test chamber.(See Note 1)				
Test Methods and							
Remarks		KP, NM, HK, HKQ, AQ, MC Series					
	Temperature	:40±2°C(LK, CK, CKS, CKP					
		:60±2°C(HK, HKQ, AQ, MC	Series)				
	Humidity	:90 to 95%RH					
	Duration	:500±12 hrs					
41	Recovery		ne standard condition after the removal from test chamber. (See Note 1)				
(Note 1) When there a	are questions concerning measurement result; measurement shall be made after 48±2 hrs of recovery under the standard condition.						

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45 1 2 1 5	11 .			
15. Loading under Dan	np Heat BK0402			
			4	
	BK0603		-	
	BK1005		-	
	BKH0603		4	
	BKH1005		4	
	BK1608		1	
	BK2125		Appearance: No significant abnormality	
	ARRAY	K2010	Impedance change: Within ±30%	
		K3216		
	BKP0402			
	BKP0603			
	BKP1005			
	BKP1608			
	BKP2125			
	CK1608		No mechanical damage.	
	CK2125		Inductance change: Within ±20% Q change: Within ±30%	
	CKS2125		No mechanical damage. Inductance change: Within ±20%	
	CKP1608			
	CKP2012			
	CKP2016		No mechanical damage.	
Specified Value	CKP2520		Inductance change: Within ±30%	
	NM2012		1	
	NM2520			
	LK1005		No mechanical damage. Inductance change: Within ±10% Q change: Within ±30%	
	LK1608		No mechanical damage. Inductance change: 0.047~12.0 µH: Within ±10% 15.0~33.0 µH: Within ±15% Q change: Within ±30%	
	LK2125		No mechanical damage. Inductance change: Within ±20% Q change: Within ±30%	
	HK0603			
	HK1005			
	HK1608			
	HK2125		1	
	HKQ0402		No mechanical damage.	
	HKQ0603W		Inductance change: Within ±10% Q change: Within ±20%	
	HKQ0603C			
	HKQ0603S		1	
	HKQ0603U		1	
	AQ105		1	
	MCFE1608		Appearance: No significant abnormality	
	MCKK2012		Inductance change: Within ±10%	
	BK, BKP, BKH Serie	s:	· · · · · · · · · · · · · · · · · · ·	
	Temperature	:40±2°C		
	Humidity :90 to 95%RH			
	Applied current : Rated current			
	Duration	:500+24/-0 hrs		
Test Methods and			der the standard condition after the removal from test chamber. (See Note 1)	
Remarks		NK、HK、HKQ、AQ、MC Serie		
i verilai və	Temperature :40±2°C(LK, CK, CKS,			
	:60±2°C(HK, HKQ, AQ,		, MU Series)	
	Humidity	: 90 to 95%RH		
	Applied current	: Rated current		
	Duration	:500 ± 12 hrs	day the standard condition ofter the removal from test sharehow (See Note 1)	
	Recovery	on" referred to herein is defin	der the standard condition after the removal from test chamber.(See Note 1)	

Note on standard condition: "standard condition" referred to herein is defined as follows:

5 to $35^{\circ}\!C\,$ of temperature, 45 to 85% relative humidity, and 86 to 106 kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of 20 ± 2°C of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure.

Unless otherwise specified, all the tests are conducted under the "standard condition."

(Note 1) Measurement shall be made after 48 ± 2 hrs of recovery under the standard condition.

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16. Loading at High To	emperature				
	BK0402				
	BK0603				
	BK1005				
	BKH0603				
	BKH1005				
			-		
	BK1608				
	BK2125		Appearance: No significant abnormality		
	ARRAY	BK2010	Impedance change: Within ±30%		
	70000	BK3216			
	BKP0402				
	BKP0603				
	BKP1005		1		
	BKP1608				
	BKP2125		1		
	MCF 0605				
			A		
	MCF 0806		Appearance: No significant abnormality		
	MCF 1210		Impedance change: Within ±20%		
	MCF 2010				
	CK1608		No mechanical damage.		
	CK2125		Inductance change: Within ±20% Q change: Within ±30%		
	CK53135		No mechanical damage.		
	CKS2125		Inductance change: Within ±20%		
	CKP1608				
Specified Value	CKP2012				
,	CKP2016		No mechanical damage.		
	CKP2520		Inductance change: Within ±30%		
			inductance change. Within ±3070		
	NM2012		4		
	NM2520				
	LK1005		No mechanical damage.		
			Inductance change: Within ±10% Q change: Within ±30%		
			No mechanical damage.		
	LK1608		Inductance change: $0.047 \sim 12.0 \mu\text{H}$: Within $\pm 10\%$ $15.0 \sim 33.0 \mu\text{H}$: Within $\pm 15\%$		
			Q change: Within ±30%		
	LK2125		No mechanical damage.		
	LIKETEO		Inductance change: Within ±20% Q change: Within ±30%		
	HK0603				
	HK1005				
	HK1608				
	HK2125		1		
	HKQ0402		No mechanical damage.		
	HKQ0603W		Inductance change: Within ±10% Q change: Within ±20%		
	HKQ0603C		and state of the s		
	HKQ0603S				
	HKQ0603U				
	AQ105				
	MCFE1608		Annaguena a Na aignifia ant abnague alita		
			Appearance: No significant abnormality		
	MCKK2012		Inductance change: Within ±10%		
	MCKK2012	eries、MCF Series:			
	MCKK2012	eries、MCF Series: :125±3°C(BK、BKH Series)			
	MCKK2012 BK, BKH, BKP Se				
	MCKK2012 BK、BKH、BKP So Temperature	: 125±3°C(BK, BKH Series)			
	MCKK2012 BK、BKH、BKP So Temperature	: 125±3°C(BK, BKH Series) : 85±3°C(BKP, MCF Series)			
	MCKK2012 BK, BKH, BKP Son Temperature Applied current	: 125±3°C(BK, BKH Series) : 85±3°C(BKP, MCF Series) : Rated current :500+24/-0 hrs			
Total Matheda and	MCKK2012 BK, BKH, BKP Soft Temperature Applied current Duration	: 125±3°C(BK, BKH Series) : 85±3°C(BKP, MCF Series) : Rated current :500+24/-0 hrs	Inductance change: Within ±10%		
Test Methods and	MCKK2012 BK, BKH, BKP Soft Temperature Applied current Duration Recovery	: 125±3°C(BK, BKH Series) : 85±3°C(BKP, MCF Series) : Rated current :500+24/-0 hrs :2 to 3 hrs of recovery under the	Inductance change: Within ±10% ne standard condition after the removal from test chamber.		
Test Methods and Remarks	MCKK2012 BK, BKH, BKP Soft Temperature Applied current Duration Recovery	: 125±3°C (BK, BKH Series) : 85±3°C (BKP, MCF Series) :Rated current :500+24/-0 hrs :2 to 3 hrs of recovery under the series of the series	Inductance change: Within ±10% ne standard condition after the removal from test chamber. s:		
	MCKK2012 BK, BKH, BKP Soft Temperature Applied current Duration Recovery LK, CK, CKS, CK	: 125±3°C (BK, BKH Series) : 85±3°C (BKP, MCF Series) :Rated current :500+24/-0 hrs :2 to 3 hrs of recovery under the series of the series	Inductance change: Within $\pm 10\%$ ne standard condition after the removal from test chamber. s:		
	MCKK2012 BK, BKH, BKP Soft Temperature Applied current Duration Recovery LK, CK, CKS, CK	: 125±3°C (BK, BKH Series) : 85±3°C (BKP, MCF Series) : Rated current : 500+24/-0 hrs : 2 to 3 hrs of recovery under the series of the series	Inductance change: Within $\pm 10\%$ ne standard condition after the removal from test chamber. s:		
	MCKK2012 BK, BKH, BKP Soft Temperature Applied current Duration Recovery LK, CK, CKS, CK	: 125±3°C (BK, BKH Series) : 85±3°C (BKP, MCF Series) : Rated current : 500+24/-0 hrs : 2 to 3 hrs of recovery under the series of the series	Inductance change: Within ±10% ne standard condition after the removal from test chamber. s: NM, MC Series)		
	MCKK2012 BK, BKH, BKP Soft Temperature Applied current Duration Recovery LK, CK, CKS, CK	: 125±3°C (BK, BKH Series) : 85±3°C (BKP, MCF Series) : Rated current : 500+24/-0 hrs : 2 to 3 hrs of recovery under the series of the series	Inductance change: Within ±10% ne standard condition after the removal from test chamber. s: NM、MC Series) rating temperature range -55~+85°C) HK1005, HKQ0603S, HKQ0603U, HKQ0603W, HKQ0603C, AQ105		
	MCKK2012 BK, BKH, BKP Soft Temperature Applied current Duration Recovery LK, CK, CKS, CK	: 125±3°C (BK, BKH Series) : 85±3°C (BKP, MCF Series) : Rated current : 500+24/-0 hrs : 2 to 3 hrs of recovery under the series of the series	Inductance change: Within ±10% ne standard condition after the removal from test chamber. s: NM、MC Series) rating temperature range -55~+85°C)		
	MCKK2012 BK, BKH, BKP So Temperature Applied current Duration Recovery LK, CK, CKS, CK Temperature Applied current	: 125±3°C (BK, BKH Series) : 85±3°C (BKP, MCF Series) : Rated current : 500+24/-0 hrs : 2 to 3 hrs of recovery under the series of the series	Inductance change: Within ±10% ne standard condition after the removal from test chamber. s: NM、MC Series) rating temperature range -55~+85°C) HK1005, HKQ0603S, HKQ0603U, HKQ0603W, HKQ0603C, AQ105		
	MCKK2012 BK, BKH, BKP So Temperature Applied current Duration Recovery LK, CK, CKS, CK Temperature	: 125±3°C (BK, BKH Series) : 85±3°C (BKP, MCF Series) :Rated current :500+24/-0 hrs :2 to 3 hrs of recovery under the series of	Inductance change: Within ±10% ne standard condition after the removal from test chamber. s: NM、MC Series) rating temperature range -55~+85°C) HK1005, HKQ0603S, HKQ0603U, HKQ0603W, HKQ0603C, AQ105		

5 to $35^{\circ}\!C$ of temperature, 45 to 85% relative humidity, and 86 to 106 kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of 20±2°C of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure. Unless otherwise specified, all the tests are conducted under the "standard condition."

(Note 1) Measurement shall be made after 48 ± 2 hrs of recovery under the standard condition.

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Precautions on the use of Multilayer chip inductors

Multilayer chip inductors for high frequency, Multilayer chip bead inductors

Multilayer common mode choke coils (MC series F type)

Metal Multilayer Chip Power Inductors (MCOILTM MC series)

PRECAUTIONS

1. Circuit Design

- ◆ Verification of operating environment, electrical rating and performance
 - 1. A malfunction in medical equipment, spacecraft, nuclear reactors, etc. may cause serious harm to human life or have severe social ramifications

Precautions

As such, any inductors to be used in such equipment may require higher safety and/or reliability considerations and should be clearly differentiated from components used in general purpose applications.

- ◆Operating Current(Verification of Rated current)
 - 1. The operating current for inductors must always be lower than their rated values.
 - 2. Do not apply current in excess of the rated value because the inductance may be reduced due to the magnetic saturation effect.

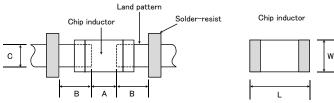
2. PCB Design

Precautions

- ◆Pattern configurations (Design of Land-patterns)
- 1. When inductors are mounted on a PCB, the size of land patterns and the amount of solder used (size of fillet) can directly affect inductor performance.

Therefore, the following items must be carefully considered in the design of solder land patterns:

- (1) The amount of solder applied can affect the ability of chips to withstand mechanical stresses which may lead to breaking or cracking. Therefore, when designing land-patterns it is necessary to consider the appropriate size and configuration of the solder pads which in turn determines the amount of solder necessary to form the fillets.
- (2) When more than one part is jointly soldered onto the same land or pad, the pad must be designed so that each component's soldering point is separated by solder-resist.
- (3) The larger size of land patterns and amount of solder, the smaller Q value after mounting on PCB. It makes higher the Q value to design land patterns smaller than terminal electrode of chips.
- ◆Pattern configurations (Inductor layout on panelized[breakaway] PC boards)
 - 1. After inductors have been mounted on the boards, chips can be subjected to mechanical stresses in subsequent manufacturing processes (PCB cutting, board inspection, mounting of additional parts, assembly into the chassis, wave soldering the reflow soldered boards etc.) For this reason, planning pattern configurations and the position of SMD inductors should be carefully performed to minimize stress.
- ◆Pattern configurations(Design of Land-patterns)
 - The following diagrams and tables show some examples of recommended patterns to prevent excessive solder amounts (larger fillets which extend above the component end terminations). Examples of improper pattern designs are also shown.
 - (1) Recommended land dimensions for a typical chip inductor land patterns for PCBs



Recommended land dimensions for wave-soldering (Unit:mm)

Ту	ре	1608	2012	2125	2016	2520	3216
Size	┙	1.6	2.0	2.0	2.0	2.5	3.2
Size	W	0.8	1.25	1.25	1.6	2.0	1.6
A	١	0.8~1.0	1.0~1.4	1.0~1.4	1.0~1.4	1.0~1.4	1.8~2.5
В		0.5~0.8	0.8~1.5	0.8~1.5	0.8~1.5	0.6~1.0	0.8~1.7
С		0.6~0.8	0.9~1.2	0.9~1.2	1.3~1.6	1.6~2.0	1.2~1.6

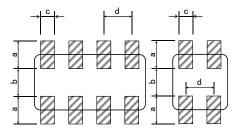
Technical considerations

Recommended land dimensions for reflow-soldering (Unit:mm)

T	уре	0402	0603	1005	105	1608	2012	2125	2016	2520	3216
Size	L	0.4	0.6	1.0	1.0	1.6	2.0	2.0	2.0	2.5	3.2
Size	W	0.2	0.3	0.5	0.6	0.8	1.25	1.25	1.6	2.0	1.6
	A	0.15~0.25	0.20~0.30	0.45~0.55	0.50~0.55	0.8~1.0	0.8~1.2	0.8~1.2	0.8~1.2	1.0~1.4	1.8~2.5
	В	0.10~0.20	0.20~0.30	0.40~0.50	0.30~0.40	0.6~0.8	0.8~1.2	0.8~1.2	0.8~1.2	0.6~1.0	0.6~1.5
	С	0.15~0.30	0.25~0.40	0.45~0.55	0.60~0.70	0.6~0.8	0.9~1.6	0.9~1.6	1.2~2.0	1.8~2.2	1.2~2.0

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Excess solder can affect the ability of chips to withstand mechanical stresses. Therefore, please take proper precautions when designing land-patterns.



Type		3216	2010	1210	0806	0605
c. L		3.2	2.0	1.25	0.85	0.65
Size	W	1.6	1.0	1.0	0.65	0.50
а	1	0.7~0.9	0.5~0.6	0.45~0.55	0.25~0.35	0.27~0.33
b		0.8~1.0	0.5~0.6	0.7~0.8	0.25~0.35	0.17~0.23
С		0.4~0.5	0.2~0.3	0.25~0.35	0.25~0.35	0.20~0.26
d		8.0	0.5	0.55	0.5	0.4

(Unit:mm)

((2) Examples of good and bad solder application

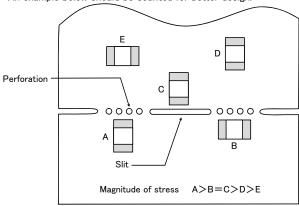
z) Examples of good and bad solde		
Item	Not recommended	Recommended
Mixed mounting of SMD and leaded components	Lead wire of component	Solder-resist
Component placement close to the chassis	Chassis Solder (for grounding) Electrode pattern	Solder-resist
Hand-soldering of leaded components near mounted components	Lead wire of component Soldering iron	Solder-resist
Horizontal component placement		Solder-resist

- ◆Pattern configurations (Inductor layout on panelized[breakaway] PC boards)
 - 1-1. The following are examples of good and bad inductor layout; SMD inductors should be located to minimize any possible mechanical stresses from board warp or deflection.

Item	Not recommended	Recommended
Deflection of the board		Position the component at a right angle to the direction of the mechanical stresses that are anticipated.

1-2. To layout the inductors for the breakaway PC board, it should be noted that the amount of mechanical stresses given will vary depending on inductor layout.

An example below should be counted for better design.



1-3. When breaking PC boards along their perforations, the amount of mechanical stress on the inductors can vary according to the method used. The following methods are listed in order from least stressful to most stressful: push-back, slit, V-grooving, and perforation. Thus, any ideal SMD inductor layout must also consider the PCB splitting procedure.

3. Considerations for automatic placement

- ◆Adjustment of mounting machine
 - 1. Excessive impact load should not be imposed on the inductors when mounting onto the PC boards.
 - 2. The maintenance and inspection of the mounter should be conducted periodically.

Precautions

◆ Selection of Adhesives

- 1. Mounting inductors with adhesives in preliminary assembly, before the soldering stage, may lead to degraded inductor characteristics unless the following factors are appropriately checked; the size of land patterns, type of adhesive, amount applied, hardening temperature and hardening period. Therefore, it is imperative to consult the manufacturer of the adhesives on proper usage and amounts of adhesive to use.
- ◆Adjustment of mounting machine
 - 1. If the lower limit of the pick-up nozzle is low, too much force may be imposed on the inductors, causing damage. To avoid this, the following points should be considered before lowering the pick-up nozzle:
 - The lower limit of the pick-up nozzle should be adjusted to the surface level of the PC board after correcting for deflection of the board.
 - (2) The pick-up pressure should be adjusted between 1 and 3N static loads.
 - (3) To reduce the amount of deflection of the board caused by impact of the pick-up nozzle, supporting pins or back-up pins should be used under the PC board. The following diagrams show some typical examples of good pick-up nozzle placement:

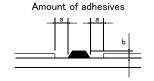
Item	Improper method	Proper method
Single-sided mounting	chipping or cracking	supporting pins — or back-up pins
Double-sided mounting	chipping or cracking	supporting pins or back-up pins

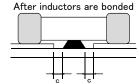
Technical considerations

- 2. As the alignment pin wears out, adjustment of the nozzle height can cause chipping or cracking of the inductors because of mechanical impact on the inductors. To avoid this, the monitoring of the width between the alignment pin in the stopped position, and maintenance, inspection and replacement of the pin should be conducted periodically.
- ◆Selection of Adhesives
 - 1. Some adhesives may cause reduced insulation resistance. The difference between the shrinkage percentage of the adhesive and that of the inductors may result in stresses on the inductors and lead to cracking. Moreover, too little or too much adhesive applied to the board may adversely affect component placement, so the following precautions should be noted in the application of adhesives.
 - (1) Required adhesive characteristics
 - a. The adhesive should be strong enough to hold parts on the board during the mounting & solder process.
 - b. The adhesive should have sufficient strength at high temperatures.
 - c. The adhesive should have good coating and thickness consistency.
 - d. The adhesive should be used during its prescribed shelf life.
 - e. The adhesive should harden rapidly.
 - f. The adhesive must not be contaminated.
 - g. The adhesive should have excellent insulation characteristics.
 - h. The adhesive should not be toxic and have no emission of toxic gasses.
 - (2) When using adhesives to mount inductors on a PCB, inappropriate amounts of adhesive on the board may adversely affect component placement. Too little adhesive may cause the inductors to fall off the board during the solder process. Too much adhesive may cause defective soldering due excessive flow of adhesive on to the land or solder pad.

[Recommended conditions]

Figure	Figure 0805 case sizes as examples	
a 0.3mm min		
b	b 100~120 μm	
c Area with no adhesive		





4. Soldering

Precautions

◆Selection of Flux

- 1. Since flux may have a significant effect on the performance of inductors, it is necessary to verify the following conditions prior to use;
 - (1) Flux used should be with less than or equal to 0.1 wt% (Chlorine conversion method) of halogenated content. Flux having a strong acidity content should not be applied.
 - (2) When soldering inductors on the board, the amount of flux applied should be controlled at the optimum level.
 - (3) When using water-soluble flux, special care should be taken to properly clean the boards.

◆Soldering

1. Temperature, time, amount of solder, etc. are specified in accordance with the following recommended conditions, and please contact us about peak temperature when you use lead-free paste.

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◆Selection of Flux

- 1-1. When too much halogenated substance (Chlorine, etc.) content is used to activate the flux, or highly acidic flux is used, an excessive amount of residue after soldering may lead to corrosion of the terminal electrodes or degradation of insulation resistance on the surface of the Inductor.
- 1-2. Flux is used to increase solderability in flow soldering, but if too much is applied, a large amount of flux gas may be emitted and may detrimentally affect solderability. To minimize the amount of flux applied, it is recommended to use a flux-bubbling system.
- 1-3. Since the residue of water-soluble flux is easily dissolved by water content in the air, the residue on the surface of Inductor in high humidity conditions may cause a degradation of insulation resistance and therefore affect the reliability of the components. The cleaning methods and the capability of the machines used should also be considered carefully when selecting water-soluble flux.

◆Soldering

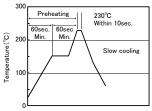
1-1. Preheating when soldering

Heating: Chip inductor components should be preheated to within $100 \text{ to } 130^{\circ}\text{C}$ of the soldering. Cooling: The temperature difference between the components and cleaning process should not be greater than 100°C .

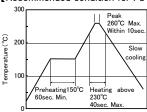
Chip inductors are susceptible to thermal shock when exposed to rapid or concentrated heating or rapid cooling. Therefore, the soldering process must be conducted with a great care so as to prevent malfunction of the components due to excessive thermal shock.

[Reflow soldering]

[Recommended conditions for eutectic soldering]



[Recommended condition for Pb-free soldering]



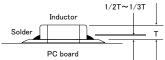
%Ceramic chip components should be preheated to within 100 to 130°C of the soldering.

*Assured to be reflow soldering for 2 times.

Caution

Technical considerations

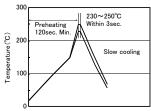
1. The ideal condition is to have solder mass(fillet) controlled to 1/2 to 1/3 of the thickness of the inductor, as shown below:



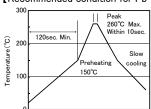
2. Because excessive dwell times can detrimentally affect solderability, soldering duration should be kept as close to recommended times as possible.

[Wave soldering]

[Recommended conditions for eutectic soldering]



[Recommended condition for Pb-free soldering]



 $\rm \& Ceramic$ chip components should be preheated to within 100 to 130 $\rm ^{\circ}C$ of the soldering.

Assured to be wave soldering for 1 time.

Except for reflow soldering type.

Assured to be wave soldering type.

Assured to be wave soldering type.

Assured to be wave soldering for 1 time.

Assured to be wave soldering type.

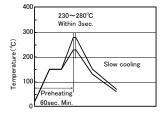
Assured to be wave s

Caution

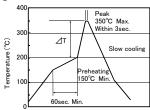
- 1. Make sure the inductors are preheated sufficiently.
- 2. The temperature difference between the inductor and melted solder should not be greater than 100 to 130° C.
- 3. Cooling after soldering should be as gradual as possible.
- 4. Wave soldering must not be applied to the inductors designated as for reflow soldering only.

[Hand soldering]

[Recommended conditions for eutectic soldering



[Recommended condition for Pb-free soldering]



(<u>%</u> <u>/</u>T≦190°C(3216Type max), <u>/</u>T≦130°C(3225 Type min)

%It is recommended to use 20W soldering iron and the tip is 1 ϕ or less.

*The soldering iron should not directly touch the components.

XAssured to be soldering iron for 1 time

Note: The above profiles are the maximum allowable soldering condition, therefore these profiles are not always recommended.

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Caution 1. Use a 20W soldering iron with a maximum tip diameter of 1.0 mm. 2. The soldering iron should not directly touch the inductor.

5. Cleaning

Precautions

considerations

♦Cleaning conditions

- 1. When cleaning the PC board after the Inductors are all mounted, select the appropriate cleaning solution according to the type of flux used and purpose of the cleaning (e.g. to remove soldering flux or other materials from the production process.)
- 2. Cleaning conditions should be determined after verifying, through a test run, that the cleaning process does not affect the inductor's characteristics.

◆Cleaning conditions

- 1. The use of inappropriate solutions can cause foreign substances such as flux residue to adhere to the inductor, resulting in a degradation of the inductor's electrical properties (especially insulation resistance).
- 2. Inappropriate cleaning conditions (insufficient or excessive cleaning) may detrimentally affect the performance of the inductors.

Technical (1) Excessive cleaning

a. In the case of ultrasonic cleaning, too much power output can cause excessive vibration of the PC board which may lead to the cracking of the inductor or the soldered portion, or decrease the terminal electrodes' strength. Thus the following conditions should be carefully checked;

Ultrasonic output Below 20W/2
Ultrasonic frequency Below 40kHz
Ultrasonic washing period 5 min. or less

6. Post cleaning processes

◆Application of resin coatings, moldings, etc. to the PCB and components.

Precautions

- 1. With some type of resins a decomposition gas or chemical reaction vapor may remain inside the resin during the hardening period or while left under normal storage conditions resulting in the deterioration of the inductor's performance.
- 2. When a resin's hardening temperature is higher than the inductor's operating temperature, the stresses generated by the excess heat may lead to inductor damage or destruction.
- 3. Stress caused by a resin's temperature generated expansion and contraction may damage inductors.

The use of such resins, molding materials etc. is not recommended.

7. Handling

- ◆Breakaway PC boards (splitting along perforations)
 - 1. When splitting the PC board after mounting inductors and other components, care is required so as not to give any stresses of deflection or twisting to the board.
 - 2. Board separation should not be done manually, but by using the appropriate devices.
- ◆General handling precautions
 - 1. Always wear static control bands to protect against ESD.
 - $\ensuremath{\mathbf{2}}.$ Keep the inductors away from all magnets and magnetic objects.
- Precautions

 3. Use non-magnetic tweezers when handling inductors.
 - 4. Any devices used with the inductors (soldering irons, measuring instruments) should be properly grounded.
 - 5. Keep bare hands and metal products (i.e., metal desk) away from chip electrodes or conductive areas that lead to chip electrodes.
 - 6. Keep inductors away from items that generate magnetic fields such as speakers or coils.
 - ◆Mechanical considerations
 - 1. Be careful not to subject the inductors to excessive mechanical shocks.
 - (1) If inductors are dropped on the floor or a hard surface they should not be used.
 - (2) When handling the mounted boards, be careful that the mounted components do not come in contact with or bump against other boards or components.

8. Storage conditions

◆Storage

1. To maintain the solderability of terminal electrodes and to keep the packaging material in good condition, care must be taken to control temperature and humidity in the storage area. Humidity should especially be kept as low as possible.

Precautions

Recommended conditions
Ambient temperature Below 30°C

Humidity Below 70% RH

The ambient temperature must be kept below 40°C. Even under ideal storage conditions inductor electrode solderability decreases as time passes, so inductors should be used within 6 months from the time of delivery.

*The packaging material should be kept where no chlorine or sulfur exists in the air.

◆Storage

Technical considerations

1. If the parts are stocked in a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place. For this reason, components should be used within 6 months from the time of delivery. If exceeding the above period, please check solderability before using the inductors.

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